



CD2535H1-长城

主要参数 MAIN CHARACTERISTICS

I _{T(RMS)}	40A
V _{DRM/V_{RRM}}	1000V
I _{GT}	35mA

用途

- 半交流开关
- 相位控制

APPLICATIONS

- Half AC switching
- Phase control

产品特性

- 玻璃钝化芯片，高可靠性和一致性
- 低通态电流和高浪涌电流能力
- 环保 RoHS 产品

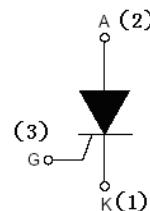
FEATURES

- Glass-passivated mesa chip for reliability and uniform
- Low on-state voltage and High I_{TSM}
- RoHS products

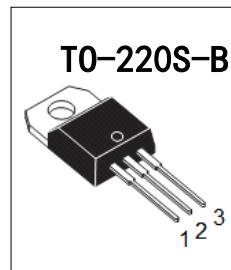
订货信息 ORDER MESSAGE

订货型号 Order codes				印 记 Marking	封 装 Package
有卤-条管	无卤-条管	有卤-编带	无卤-编带		
Halogen-Tube	halogen-Free-Tube	Halogen-Reel	Halogen-Free-Reel		
CD2535H1-CD-B	CD2535H1 -CD-BR	N/A	N/A	CD2535H1	TO-220S-B

封装 Package



序号 Pin	引线名称 Description
1	阴极 K
2	阳极 A
3	门极 G



Non-insulated

绝对最大额定值 ABSOLUTE RATINGS ($T_c=25^\circ\text{C}$)

PARAMETER	SYMBOL	TEST CONDITIONS		VALUES	UNITS	
Maximum average on-state current	$I_{T(AV)}$	$T_c = 93^\circ\text{C}$, 180° conduction half sine wave		25	A	
Maximum RMS on-state current	I_{RMS}			40		
Maximum peak, one-cycle non-repetitive surge current	I_{TSM}	10 ms sine pulse, rated V_{RRM} applied		300		
		10 ms sine pulse, no voltage reapplied		350		
Maximum I^2t for fusing	I^2t	10 ms sine pulse, rated V_{RRM} applied		450	A^2s	
		10 ms sine pulse, no voltage reapplied		630		
Maximum $I^2\sqrt{t}$ for fusing	$I^2\sqrt{t}$	$t = 0.1$ to 10 ms, no voltage reapplied		6300	$\text{A}^2\sqrt{\text{s}}$	
Maximum on-state voltage	V_{TM}	$80 \text{ A}, T_J = 25^\circ\text{C}$		1.6	V	
Low level value of on-state slope resistance	r_t	$T_J = 140^\circ\text{C}$		11.4	$\text{m}\Omega$	
Low level value of threshold voltage	$V_{T(TO)}$			0.96	V	
Maximum reverse and direct leakage current	I_{RRM}/I_{DRM}	$T_J = 25^\circ\text{C}$	$V_R = \text{Rated } V_{RRM}/V_{DRM}$	0.5	mA	
		$T_J = 140^\circ\text{C}$		12		
Holding current	I_H	Anode supply = 6 V, resistive load, initial $I_T = 1 \text{ A}$, $T_J = 25^\circ\text{C}$		100		
Maximum latching current	I_L	Anode supply = 6 V, resistive load, $T_J = 25^\circ\text{C}$		200		
Maximum rate of rise of off-state voltage	dV/dt	$T_J = T_J \text{ max.}$, linear to 80 °C, $V_{DRM} = R_g - k = \text{Open}$		500	V/ μ s	
Maximum rate of rise of turned-on current	dI/dt			150	A/ μ s	
Storage temperature	T_{stg}			-40~150	°C	
Operation junction temperature	T_J			-40~150	°C	
Electro static discharge	ESD	人体模式		3000	V	
Moisture sensitivity level	MSL	MSL=3				



CD2535H1

触发特性 TRIGGERING CHARACTERISTICS ($T_c=25^\circ\text{C}$ unless otherwise stated)

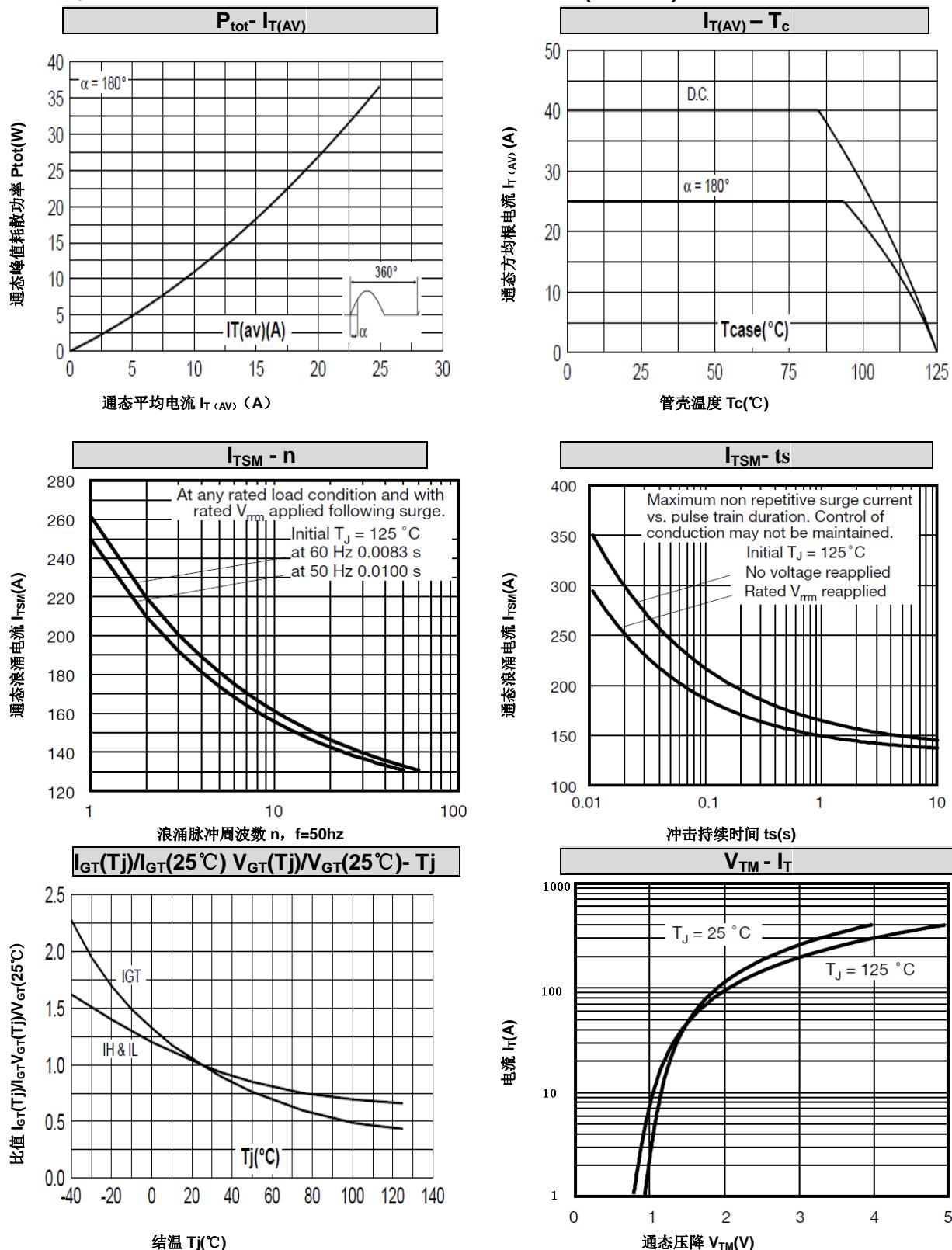
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNIT
Maximum peak gate power	P_{GM}		8.0	W
Maximum average gate power	$P_{G(AV)}$		2.0	
Maximum peak positive gate current	$+I_{GM}$		1.5	A
Maximum peak negative gate voltage	$-V_{GM}$		10	V
Maximum required DC gate current to trigger	I_{GT}	Anode supply = 6 V, resistive load, $T_J = 25^\circ\text{C}$	35	mA
Maximum required DC gate voltage to trigger	V_{GT}	Anode supply = 6 V, resistive load, $T_J = 25^\circ\text{C}$	1.3	V
Maximum DC gate voltage not to trigger	V_{GD}	$T_J = 140^\circ\text{C}$, V_{DRM} = Rated value	0.2	
Maximum DC gate current not to trigger	I_{GD}		1.5	mA

热特性 THERMAL CHARACTERISTIC

项 目 Parameter	符 号 Symbol	值 value	单位 Unit
结到管壳的热阻 Thermal resistance junction to case	$R_{th(j-c)}$	0.8max	°C/W

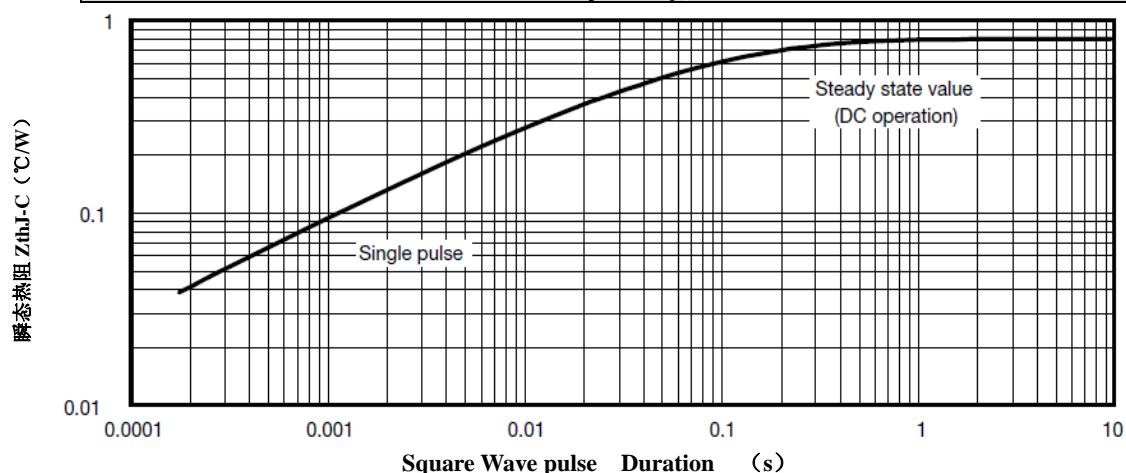
丝印信息 IMPRINT INFORMATION

丝印图片 Imprint Picture	丝印内容 Imprint Content	丝印含义 Imprint Meaning
 B		华微电子LOGO
CD2535H1	B	TO-220S-B封装
GP A1CP	CD2535H1	产品印记
	GP	芯片和封装代码
	A1CP	流水号

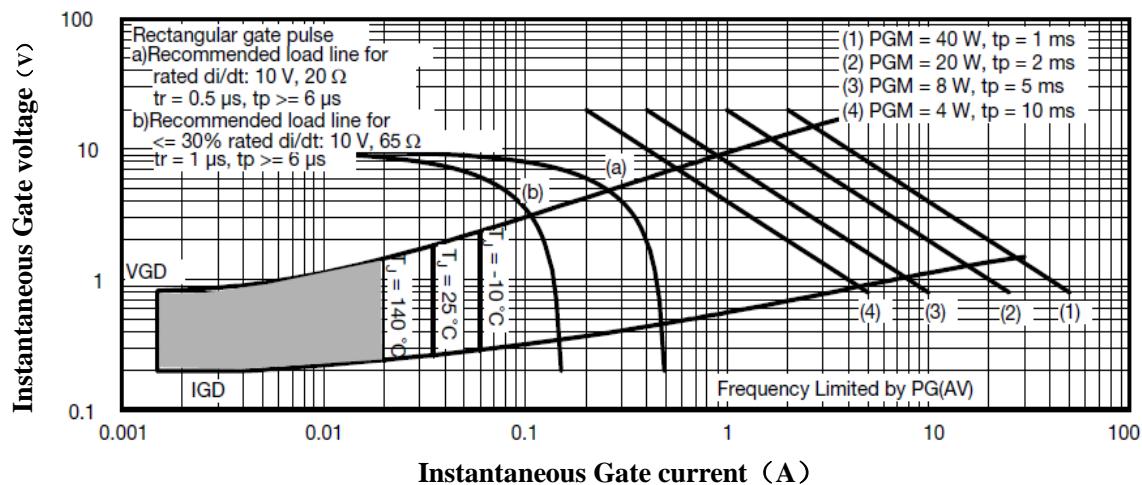
特征曲线 ELECTRICAL CHARACTERISTICS (curves)


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Zthj-c -tp



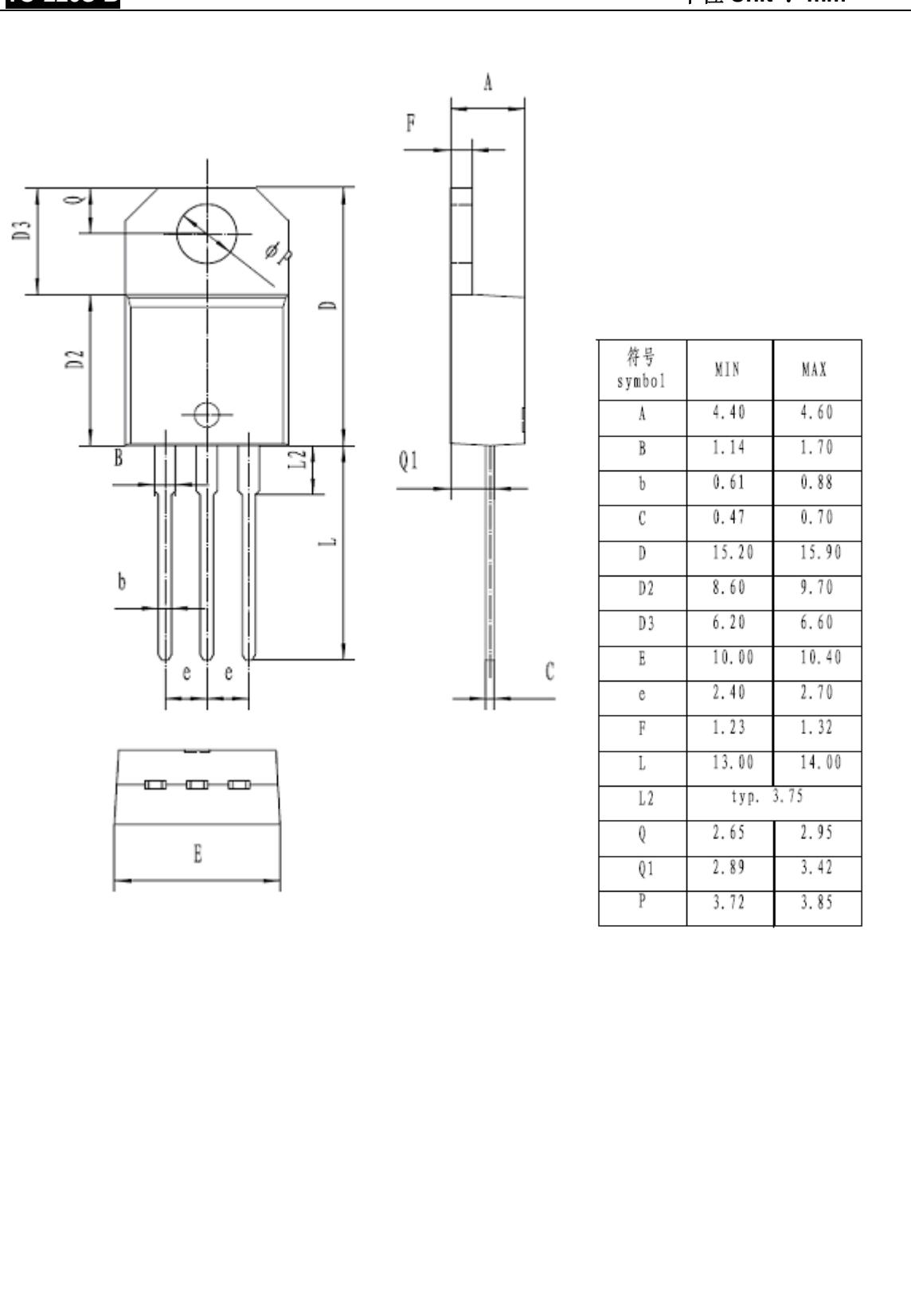
VGT-IGT



外形尺寸 PACKAGE MECHANICAL DATA

TO-220S-B

单位 Unit : mm





注意事项

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2. 购买时请认清公司商标，如有疑问请与公司本部联系。
3. 在电路设计时请不要超过器件的绝对最大额定值，否则会影响整机的可靠性。
4. 本说明书如有版本变更不另外告知。

NOTE

1. Jilin Sino-microelectronics co., Ltd sales its product either through direct sales or sales agent , thus, for customers, when ordering , please check with our company.
2. We strongly recommend customers check carefully on the trademark when buying our product, if there is any question, please don't be hesitate to contact us.
3. Please do not exceed the absolute maximum ratings of the device when circuit designing.
4. Jilin Sino-microelectronics co., Ltd reserves the right to make changes in this. specification sheet and is subject to change without prior notice.

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